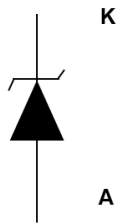
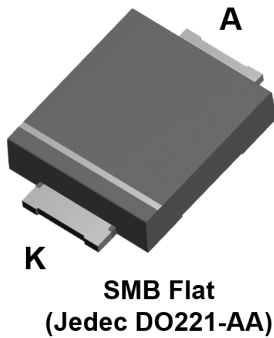


1500 W TVS in SMB Flat



Unidirectional

Product status link

SMB15FxxA series

SMB15F5.0A, SMB15F6.0A,
SMB15F6.5A, SMB15F8.5A,
SMB15F10A, SMB15F11A, SMB15F13A,
SMB15F12A, SMB15F14A, SMB15F15A,
SMB15F16A, SMB15F18A, SMB15F20A,
SMB15F22A, SMB15F23A, SMB15F24A,
SMB15F26A, SMB15F28A, SMB15F30A,
SMB15F31A, SMB15F33A, SMB15F36A,
SMB15F40A, SMB15F48A, SMB15F58A,
SMB15F64A

Features

- Peak pulse power: 1500 W (10/1000 μ s) and 10 kW (8/20 μ s)
- Flat and thin package: 1 mm
- Stand-off voltage range: from 5 V to 64 V
- Unidirectional type
- Low leakage current: 0.2 μ A at 25 °C and 1 μ A at 85 °C
- Operating T_j max: 175 °C
- High power capability at T_j max.: 1100 W (10/1000 μ s)
- Lead finishing: matte tin plating

Complies with the following standards

- UL94, V0
- J-STD-020 MSL level 1
- J-STD-002, JESD 22-B102 E3 and MIL-STD-750, method 2026 solderable matte tin plated leads
- JESD-201 class 2 whisker test
- IPC7531 footprint
- JEDEC registered package outline
- IEC 61000-4-4 level 4:
 - 4 kV
- IEC 61000-4-2, C = 150 pF - R = 330 Ω exceeds level 4:
 - 30 kV (air discharge)
 - 30 kV (contact discharge)

Description

The SMB15FxxA series are designed to protect sensitive circuits against surges.

The Planar technology makes it compatible with high-end circuits where low leakage current and high junction temperature are required to provide long term reliability and stability.

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

| Symbol | Parameter | Value | Unit | |
|-----------|--|---|--------------------|----|
| V_{PP} | Peak pulse voltage | IEC 61000-4-2 (C = 150 pF, R = 330 Ω) | kV | |
| | | Contact discharge | | 30 |
| | | Air discharge | | 30 |
| P_{PP} | Peak pulse power dissipation | 10/1000 μs , T_j initial = T_{amb} | W | |
| T_{stg} | Storage temperature range | -65 to +175 | $^{\circ}\text{C}$ | |
| T_j | Operating junction temperature range | -55 to +175 | $^{\circ}\text{C}$ | |
| T_L | Maximum lead temperature for soldering during 10 s | 260 | $^{\circ}\text{C}$ | |

Figure 1. Electrical characteristics - parameter definitions

- V_{RM} Maximum stand-off voltage
- I_{RM} Maximum leakage current @ V_{RM}
- V_R Stand-off voltage
- I_R Leakage current @ V_R
- V_{BR} Breakdown voltage @ I_{BR}
- I_{BR} Breakdown current
- V_{CL} Clamping voltage @ I_{PP}
- I_{PP} Peak pulse current
- R_D Dynamic resistance
- V_F Forward voltage drop @ I_F
- I_F Forward current
- αT Voltage temperature coefficient

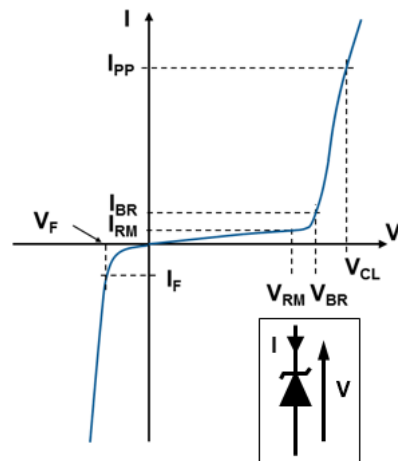


Figure 2. Pulse definition for electrical characteristics

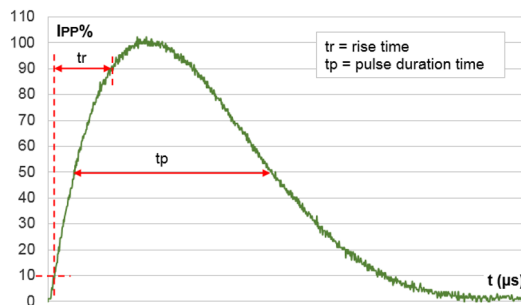


Table 2. Electrical characteristics - parameter values (T_{amb} = 25 °C, unless otherwise specified)

| Type | I _{RM} max at V _{RM} | | | V _{BR} at I _{BR} ⁽¹⁾ | | | | 10 / 1000 μs | | | 8 / 20μs | | | αT |
|------------|--|-------|-----|---|------|------|----|-----------------------------------|--------------------------------|----------------|-----------------------------------|--------------------------------|----------------|----------------------|
| | | | | | | | | V _{CL} ⁽²⁾⁽³⁾ | I _{PP} ⁽⁴⁾ | R _D | V _{CL} ⁽²⁾⁽³⁾ | I _{PP} ⁽⁴⁾ | R _D | |
| | 25 °C | 85 °C | | Min. | Typ. | Max. | | Max. | | Max. | Max. | | Max. | |
| | μA | | V | V | | | mA | V | A | Ω | V | A | Ω | 10 ⁻⁴ /°C |
| SMB15F5.0A | 20 | 50 | 5.0 | 6.4 | 6.74 | 7.1 | 10 | 9.2 | 171 | 0.012 | 13.4 | 746 | 0.008 | 5.7 |
| SMB15F6.0A | 20 | 50 | 6.0 | 6.7 | 7.05 | 7.4 | 10 | 10.3 | 152 | 0.019 | 13.7 | 730 | 0.009 | 5.9 |
| SMB15F6.5A | 20 | 50 | 6.5 | 7.2 | 7.58 | 8 | 10 | 11.2 | 140 | 0.023 | 14.5 | 690 | 0.009 | 6.1 |
| SMB15F8.5A | 20 | 50 | 8.5 | 9.4 | 9.9 | 10.4 | 1 | 14.4 | 105 | 0.038 | 19.5 | 512 | 0.018 | 7.3 |
| SMB15F10A | 0.2 | 1 | 10 | 11.1 | 11.7 | 12.3 | 1 | 17 | 92 | 0.051 | 21.7 | 461 | 0.020 | 7.8 |
| SMB15F11A | 0.2 | 1 | 11 | 12.3 | 13 | 13.7 | 1 | 18 | 85 | 0.051 | 24.2 | 413 | 0.025 | 8.1 |
| SMB15F12A | 0.2 | 1 | 12 | 13.3 | 14 | 14.7 | 1 | 19.9 | 79 | 0.066 | 25.3 | 394 | 0.027 | 8.3 |
| SMB15F13A | 0.2 | 1 | 13 | 14.4 | 15.2 | 16 | 1 | 21.5 | 73 | 0.075 | 27.2 | 368 | 0.030 | 8.4 |
| SMB15F14A | 0.2 | 1 | 14 | 15.7 | 16.5 | 17.3 | 1 | 23.1 | 67 | 0.087 | 29 | 338 | 0.035 | 8.6 |
| SMB15F15A | 0.2 | 1 | 15 | 16.7 | 17.6 | 18.5 | 1 | 24.4 | 64 | 0.092 | 32.5 | 308 | 0.045 | 8.8 |
| SMB15F16A | 0.2 | 1 | 16 | 17.9 | 18.8 | 19.8 | 1 | 26 | 58 | 0.107 | 34.7 | 293 | 0.049 | 9.0 |
| SMB15F18A | 0.2 | 1 | 18 | 20 | 21.1 | 22.2 | 1 | 29.2 | 53 | 0.132 | 39.3 | 254 | 0.067 | 9.2 |
| SMB15F20A | 0.2 | 1 | 20 | 22.2 | 23.4 | 24.6 | 1 | 32.4 | 48 | 0.163 | 42.8 | 234 | 0.078 | 9.4 |
| SMB15F22A | 0.2 | 1 | 22 | 24.4 | 25.7 | 27 | 1 | 35.5 | 44 | 0.193 | 48.3 | 207 | 0.103 | 9.6 |
| SMB15F23A | 0.2 | 1 | 23 | 25.7 | 27 | 28.4 | 1 | 37.8 | 41 | 0.229 | 49.2 | 202 | 0.103 | 9.6 |
| SMB15F24A | 0.2 | 1 | 24 | 26.7 | 28.1 | 29.5 | 1 | 38.9 | 40 | 0.235 | 50 | 200 | 0.103 | 9.6 |
| SMB15F26A | 0.2 | 1 | 26 | 28.9 | 30.4 | 31.9 | 1 | 42.1 | 37 | 0.276 | 53.5 | 187 | 0.116 | 9.7 |
| SMB15F28A | 0.2 | 1 | 28 | 31.1 | 32.7 | 34.3 | 1 | 45.4 | 34 | 0.326 | 59 | 169 | 0.146 | 9.8 |
| SMB15F30A | 0.2 | 1 | 30 | 33.2 | 35 | 36.8 | 1 | 48.4 | 32 | 0.363 | 64.3 | 156 | 0.176 | 9.9 |
| SMB15F31A | 0.2 | 1 | 31 | 34.2 | 36 | 37.8 | 1 | 50.2 | 31 | 0.400 | 65 | 153 | 0.178 | 9.9 |
| SMB15F33A | 0.2 | 1 | 33 | 36.7 | 38.6 | 40.5 | 1 | 53.3 | 29 | 0.441 | 69.7 | 143 | 0.204 | 10 |
| SMB15F36A | 0.2 | 1 | 36 | 40 | 42.1 | 44.2 | 1 | 58.1 | 26 | 0.539 | 76 | 131 | 0.243 | 10 |
| SMB15F40A | 0.2 | 1 | 40 | 44.4 | 46.7 | 49 | 1 | 64.5 | 24 | 0.646 | 84 | 119 | 0.294 | 10.1 |
| SMB15F48A | 0.2 | 1 | 48 | 53.2 | 56 | 58.8 | 1 | 77.4 | 20 | 0.930 | 100 | 100 | 0.412 | 10.3 |
| SMB15F58A | 0.2 | 1 | 58 | 64.6 | 68 | 71.4 | 1 | 93.6 | 16 | 1.39 | 121 | 83 | 0.598 | 10.4 |
| SMB15F64A | 0.2 | 1 | 64 | 71.1 | 74.8 | 78.6 | 1 | 103 | 14.6 | 1.66 | 134 | 75 | 0.74 | 10.5 |

1. To calculate V_{BR} versus T_j: V_{BR} at T_j = V_{BR} at 25 °C x (1 + αT x (T_j - 25))
2. To calculate V_{CL} versus T_j: V_{CL} at T_j = V_{CL} at 25 °C x (1 + αT x (T_j - 25))
3. To calculate V_{CL} max versus I_{PPappli}: V_{CLmax} = V_{BR} max + R_D x I_{PPappli}
4. Surge capability given for both directions

1.1 Characteristics (curves)

Figure 3. Maximum peak power dissipation versus initial junction temperature

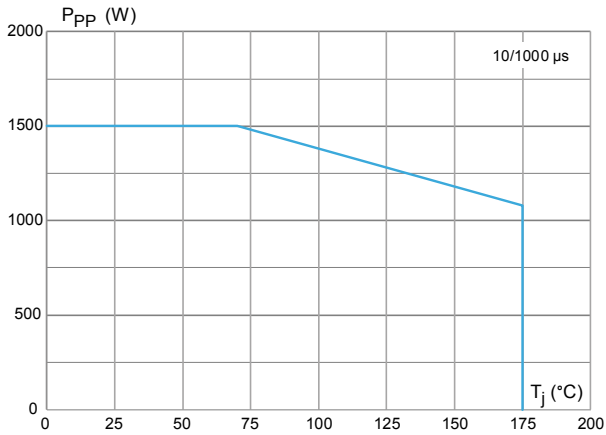


Figure 4. Maximum peak pulse power versus exponential pulse duration

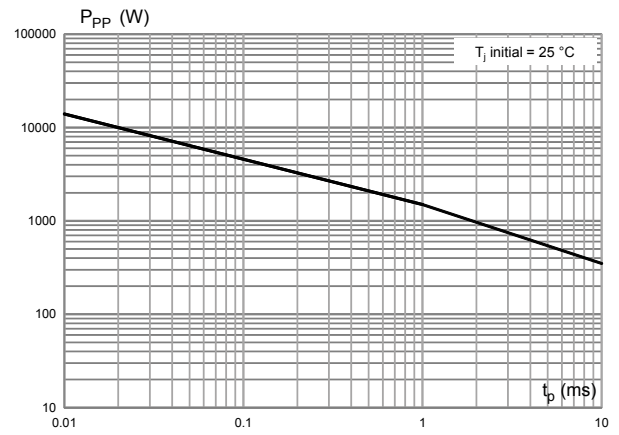


Figure 5. Maximum peak pulse current versus clamping voltage

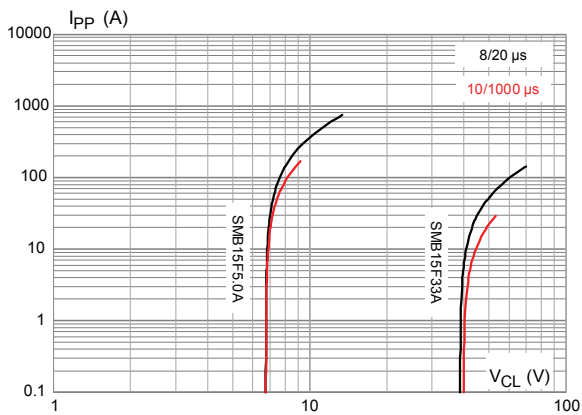


Figure 6. Dynamic resistance versus pulse duration

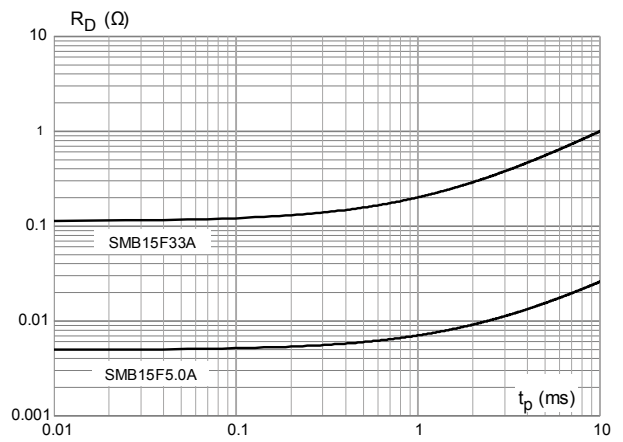


Figure 7. Junction capacitance versus reverse applied voltage (unidirectional types)

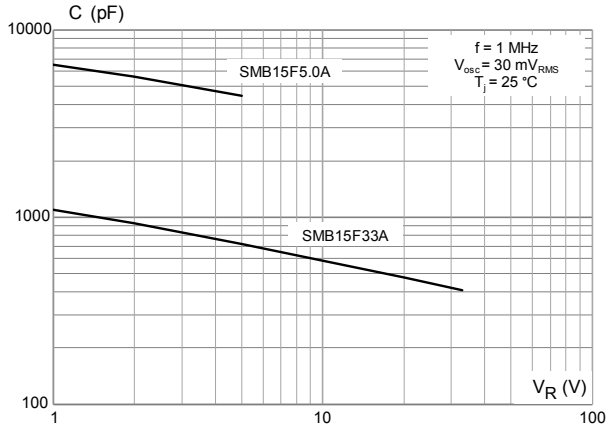


Figure 8. Leakage current versus junction temperature

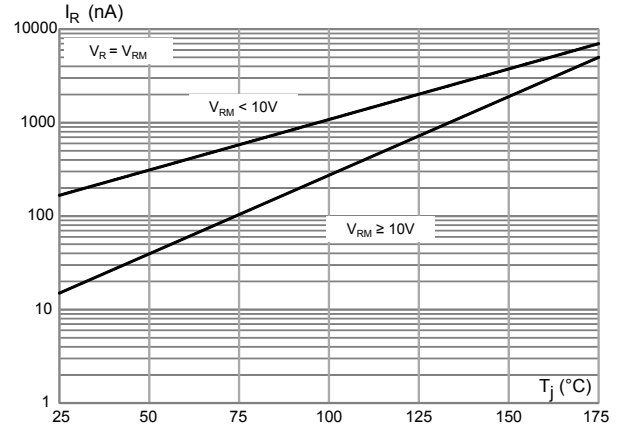


Figure 9. Peak forward voltage drop versus peak forward current

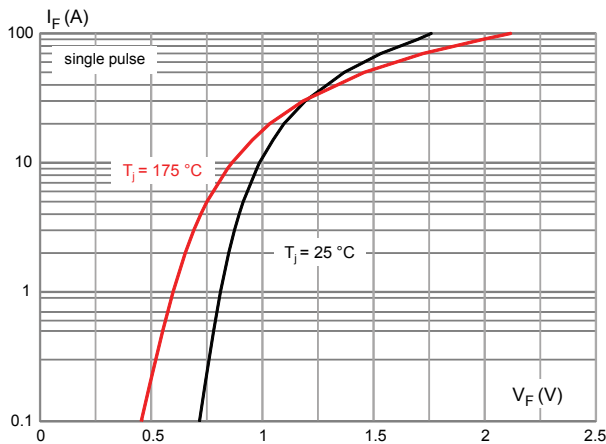


Figure 10. Thermal impedance junction to ambient versus pulse duration

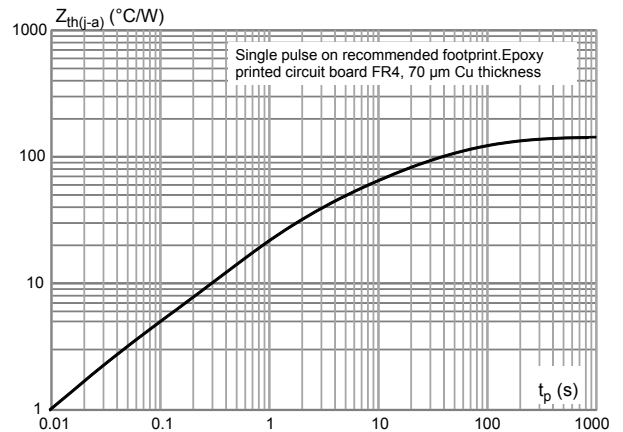
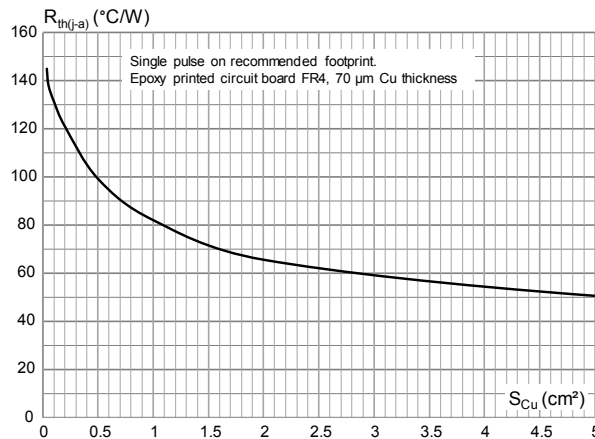


Figure 11. Thermal resistance junction to ambient versus copper area under each lead (SMB Flat)



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SMB Flat package information

Figure 12. SMB Flat package outline

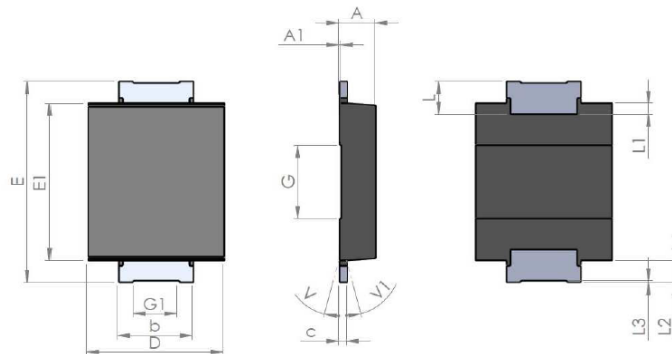


Table 3. SMB Flat mechanical data

| Ref. | Dimensions | | | | | |
|------|-------------|------|------|-----------------------|-------|-------|
| | Millimeters | | | Inches ⁽¹⁾ | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 0.90 | | 1.10 | 0.035 | | 0.044 |
| A1 | | 0.05 | | | 0.002 | |
| b | 1.95 | | 2.20 | 0.076 | | 0.087 |
| c | 0.15 | | 0.40 | 0.005 | | 0.016 |
| D | 3.30 | | 3.95 | 0.129 | | 0.156 |
| E | 5.20 | | 5.60 | 0.204 | | 0.221 |
| E1 | 4.05 | | 4.60 | 0.159 | | 0.182 |
| G | | 2.00 | | | 0.079 | |
| G1 | | 1.20 | | | 0.047 | |
| L | 0.75 | | 1.20 | 0.029 | | 0.048 |
| L1 | | 0.30 | | | 0.012 | |
| L2 | | 0.60 | | | 0.024 | |
| L3 | 0.02 | | | 0.000 | | |
| V | | | 8° | | | 8° |
| V1 | | | 8° | | | 8° |

1. Values in inches are converted from mm and rounded to 3 decimal digits.

Figure 13. Footprint recommendations, dimensions in mm (inches)

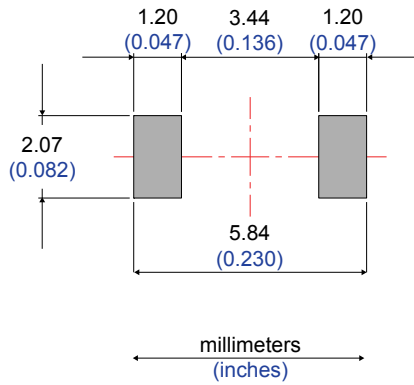


Figure 14. Marking layout (refer to ordering information table for marking)

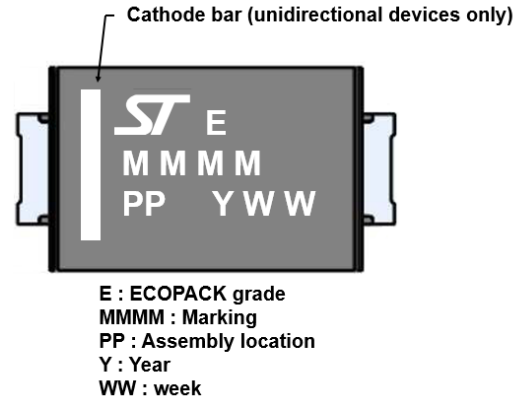
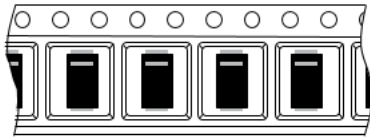


Figure 15. Package orientation in reel



Taped according to EIA-481
Note: Pocket dimensions are not on scale
Pocket shape may vary depending on package
On bidirectional devices, marking and logo may be not always in the same direction

Figure 16. Tape and reel orientation

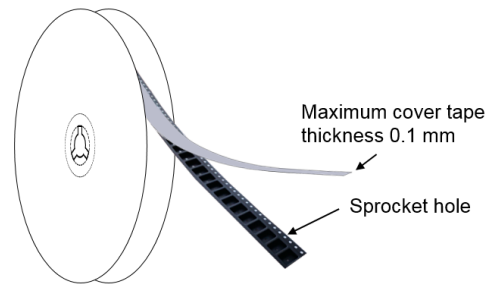


Figure 17. Reel dimensions (mm)

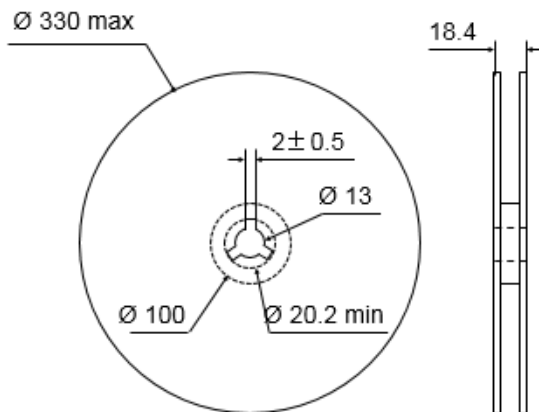


Figure 18. Inner box dimensions (mm)

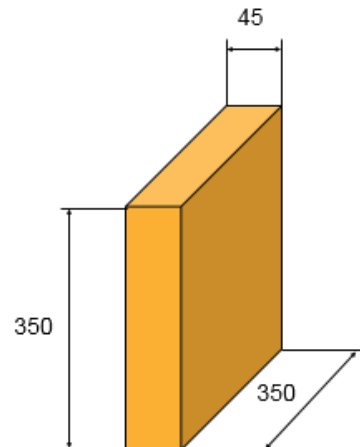
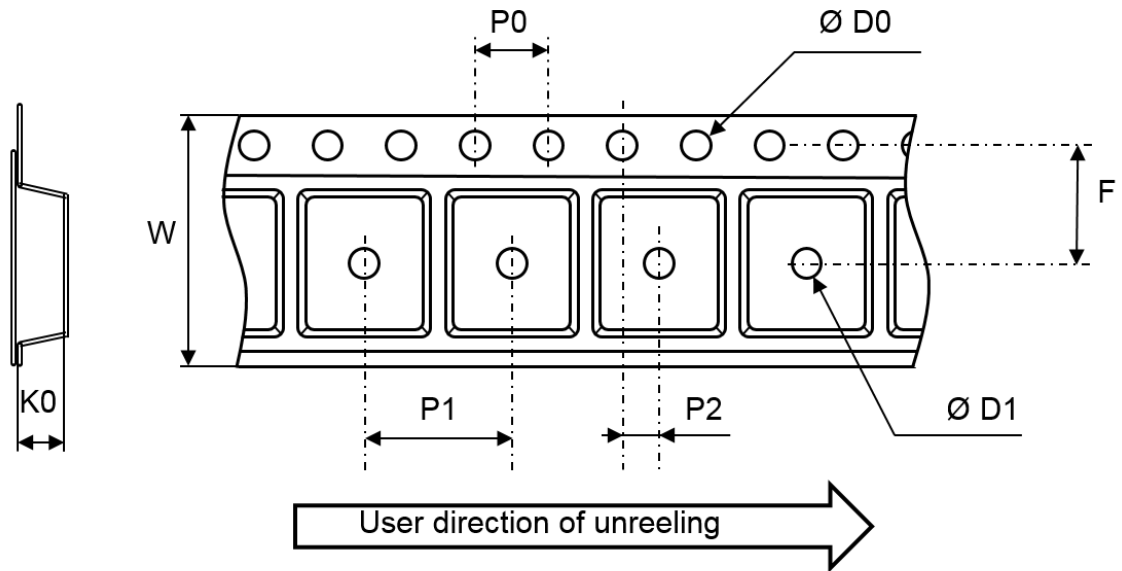


Figure 19. Tape and reel outline



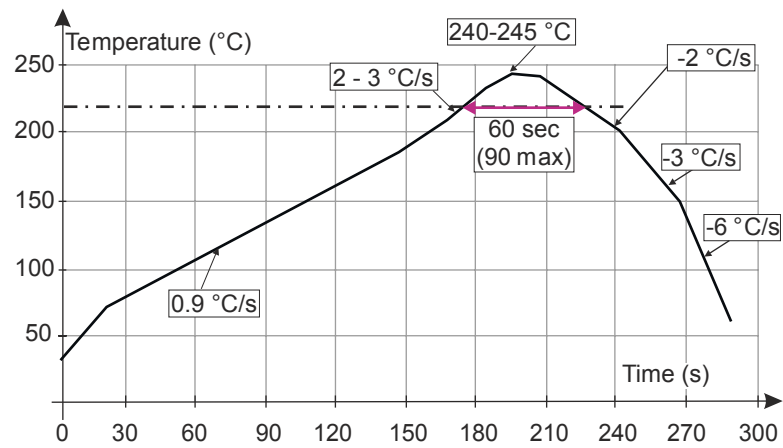
Note: Pocket dimensions are not on scale
Pocket shape may vary depending on package

Table 4. Tape and reel mechanical data

| Ref. | Dimensions | | |
|------|-------------|------|------|
| | Millimeters | | |
| | Min. | Typ. | Max. |
| ØD0 | 1.45 | 1.50 | 1.55 |
| ØD1 | 1.5 | | |
| F | 5.4 | 5.5 | 5.6 |
| K0 | 1.2 | 1.3 | 1.4 |
| P0 | 3.9 | 4.0 | 4.1 |
| P1 | 7.9 | 8.0 | 8.1 |
| P2 | 1.9 | 2.0 | 2.1 |
| W | 11.7 | 12.0 | 12.3 |

2.2 Reflow profile

Figure 20. ST ECOPACK recommended soldering reflow profile for PCB mounting



Note: Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

3 Ordering information

Figure 21. Ordering information scheme

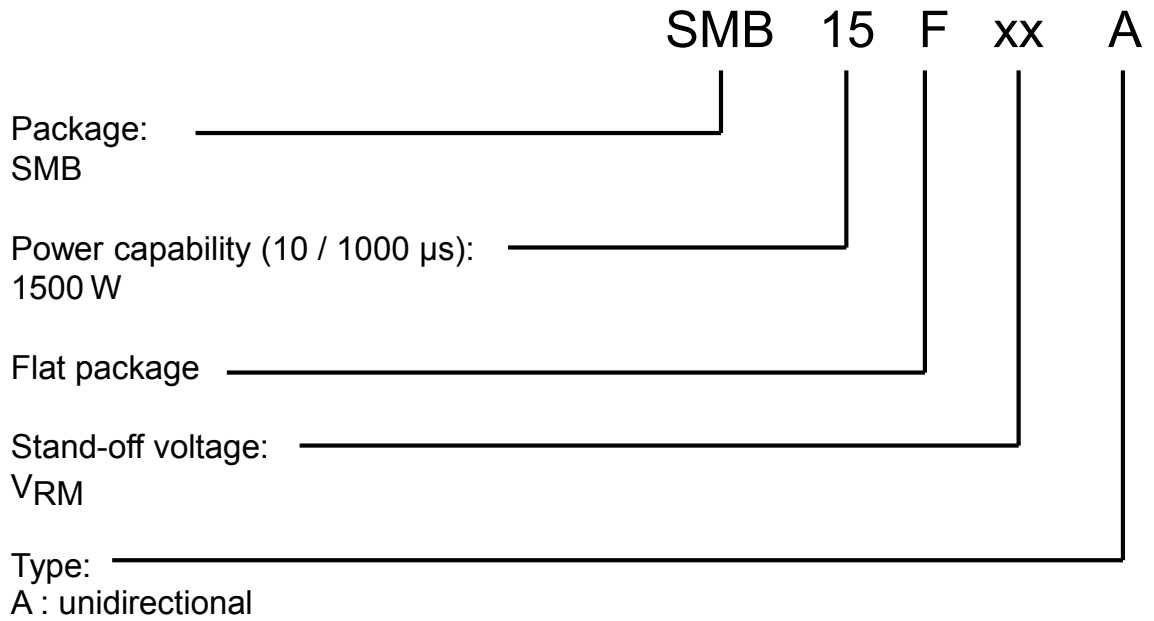


Table 5. Ordering information

| Order code | Marking | Package | Weight | Base qty. | Delivery mode |
|------------|-----------------------|----------|--------|-----------|---------------|
| SMB15FxxA | See Table 6. Marking. | SMB Flat | 60 mg | 5000 | Tape and reel |

Table 6. Marking

| Order code | Marking |
|------------|---------|
| SMB15F5.0A | FAI |
| SMB15F6.0A | FAK |
| SMB15F6.5A | FAL |
| SMB15F8.5A | FAP |
| SMB15F10A | FAS |
| SMB15F11A | FAU |
| SMB15F12A | FAW |
| SMB15F13A | FAY |
| SMB15F14A | FBA |
| SMB15F15A | FBC |
| SMB15F16A | FBE |
| SMB15F18A | FBI |
| SMB15F20A | FBM |
| SMB15F22A | FBO |
| SMB15F23A | FBP |
| SMB15F24A | FBQ |
| SMB15F26A | FBS |
| SMB15F28A | FBU |
| SMB15F30A | FBW |
| SMB15F31A | FBX |
| SMB15F33A | FBZ |
| SMB15F36A | FCC |
| SMB15F40A | FCG |
| SMB15F48A | FCO |
| SMB15F58A | FCY |
| SMB15F64A | FDE |

Revision history

Table 7. Document revision history

| Date | Revision | Changes |
|-------------|----------|------------------|
| 31-Aug-2020 | 1 | Initial release. |

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